## COPYRIGHT TRANSFER AGREEMENT THE INSTITUTE OF ELECTRONICS, INFORMATION AND COMMUNICATION ENGINEERS (IEICE)

This signed statement must be received by the Institute of Electronics, Information and Communication Engineers (the "IEICE") when your manuscript is first submitted to a publication in the proceeding of the following conference. By signing this statement, the author(s) are agreeing to be bound by the IEICE Provisions on Copyright

https://www.ieice.org/jpn/about/kitei/chosakukenkitei.pdf (Japanese) https://www.ieice.org/eng/copyright/files/copyright.pdf (English)

771	<b>™</b> T	C .1	$\sim$ $^{\circ}$	
Ihe	Name	of the	Conferen	ce.
1110	Name	OI LIIC	Connector	vv.

MWP2020 (International Topical Meeting on Microwave Photonics 2020)

Date: September 23 – 26, 2020 Place: Kunibiki Messe, Matsue URL: <a href="http://www.mwp2020.org">http://www.mwp2020.org</a>

Title of the manuscript: (Paper ID:

In the event the following manuscript is not accepted or is withdrawn by the author(s) before acceptance, this agreement becomes null and void.

)						
Author(s)						
Affiliation(s):						

)

## **Copyright Transfer**

All copyrights of the above manuscript, including rights for publishing in any media, are transferred to the IEICE.

The authors retain the following rights:

- 1. All proprietary rights other than copyrights.
- 2. Re-use of all or part of the above manuscript in their work.
- 3. Reproduction of the above manuscript for author's personal use or for company/institution use provided that
  - (a) the permission of the IEICE is obtained prior to reproduction,
  - (b) the source and IEICE copyright notice are indicated, and
  - (c) the copies *per se* are not offered for sale.
- 4. The consent of the author (or one of the authors) be sought as a condition in granting republication permission to others.

Authorized signature	
Job title, if not author	
Date (Month/Day/Year)	